Specification of Thermoelectric Module

TEC1-07105

Description

The 71 couples, 30 mm × 30 mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	8.9	9.6	Voltage applied to the module at DT _{max}	
I _{max} (amps)	5	5	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	28.0	30.6	Cooling capacity at cold side of the module under DT = 0 °C	
AC resistance (ohms)	1.4	1.5	The module resistance is tested under AC	
Tolerance (%)	10%		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters

Positive lead wire (Red) 20 AWG leads PVC insulated Negative lead wire (Black) 125±1 Cold side:Tc See ordering option See ordering option See ordering option

Manufacturing Options

- A. Solder:
- 1. T100: BiSn (Tmelt=138°C)
- 2. T200: CuSn (Tmelt = 227 °C)
- **B. Sealant:**
- 1. NS: No sealing (Standard)
- 2. SS: Silicone sealant
- 3. EPS: Epoxy sealant
- 4. Customer specify sealing other than above

C. Ceramics:

- 1. Alumina (Al₂O₃, white 96%)
- 2. Aluminum Nitride (AlN)

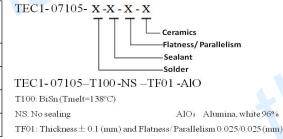
D. Ceramics Surface Options:

- 1. Blank ceramics (not metallized)
- 2. Metallized (Au plating)

Ordering Option

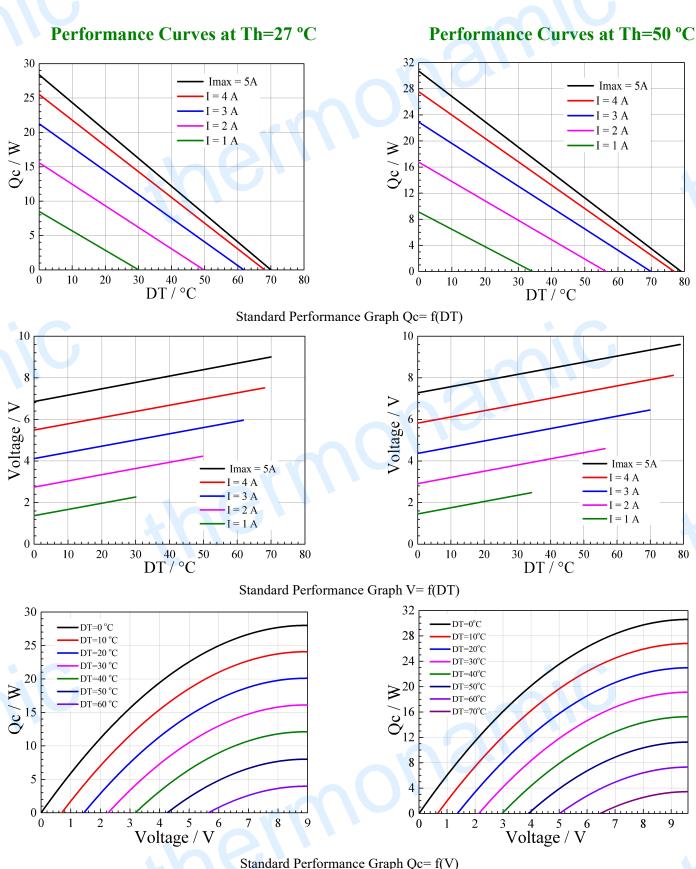
Suffix	Thickness	Flatness/	Lead wire length(mm)		
	H (mm)	Parallelism (mm)	Standard/Optional length		
TF	$0:3.95 \pm 0.1$	0:0.05/0.05	125±1/Specify		
TF	$1:3.95 \pm 0.05$	1:0.025/0.025	125±1/Specify		
TF	$2:3.95\pm0.025$	2:0.015/0.015	125±1/Specify		
Eg. TF01: Thickness 3.95± 0.1 (mm) and Flatness 0.025/0.025 (mm)					

Naming for the Module



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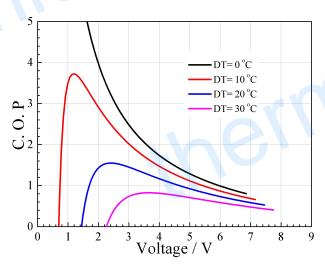


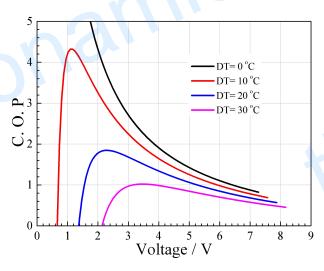
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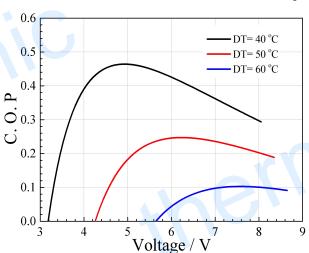
Performance Curves at Th=27 °C

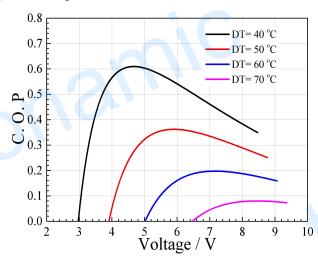
Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.